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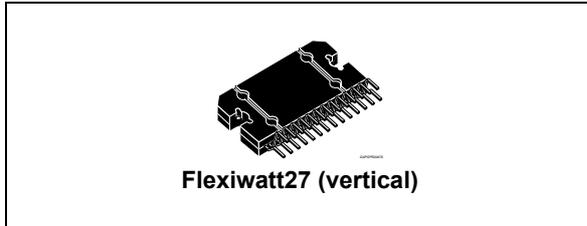
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## 4 x 45 W power amplifier with full I<sup>2</sup>C diagnostics, high efficiency, SSR and low voltage operation

Datasheet - production data



- ESD protection
- Very robust against misconnections
- Improved SVR suppression during battery transients
- Capable to operate down to 6 V (e.g. "Start-stop")
- SSR (speaker safety routine)

### Features

- Multipower BCD technology
- MOSFET output power stage
- DMOS power output
- High efficiency (class SB)
- High output power capability 4x25 W/4 Ω @ 14.4 V, 1 kHz, 10% THD, 4 x 45 W max power
- 2 Ω driving capability (64 W max power)
- Full I<sup>2</sup>C bus driving:
  - Standby
  - Independent front/rear soft play/mute
  - Selectable gain 30 dB /16 dB (for low noise line output function)
  - High efficiency enable/disable
  - I<sup>2</sup>C bus digital diagnostics (including DC and AC load detection)
- Flexible fault detection through integrated diagnostic
- DC offset detection
- Four independent short circuit protection
- Clipping detector pin with selectable threshold (2 %/10 %)
- Standby/mute pin
- Linear thermal shutdown with multiple thermal warning

### Description

The TDA75613LV is a new quad bridge car radio amplifier, designed in BCD technology, in order to include a wide range of innovative features in a very compact and flexible device.

The TDA75613LV is equipped with the most complete diagnostics array that communicates the status of each speaker through the I<sup>2</sup>C bus.

The dissipated output power under average listening condition is significantly reduced when compared to the conventional class AB solutions, thanks to the patented 'class SB' efficiency concept. TDA75613LV has been designed to be very robust against several kinds of misconnections.

The TDA75613LV is equipped with the SSR (speaker safety routine), a procedure able to check the offset at the speakers and automatically shut down the power amplifier in case of dangerous DC voltage.

It is moreover compliant to the most recent OEM specifications for low voltage operation (so called 'start-stop' battery profile during engine stop), helping car manufacturers to reduce the overall emissions and thus contributing to environment protection.

Table 1. Device summary

Order code	Package	Packing
TDA75613LV	Flexiwatt27 (vertical)	Tube

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# 1 Block diagram and application circuits

Figure 1. Block diagram

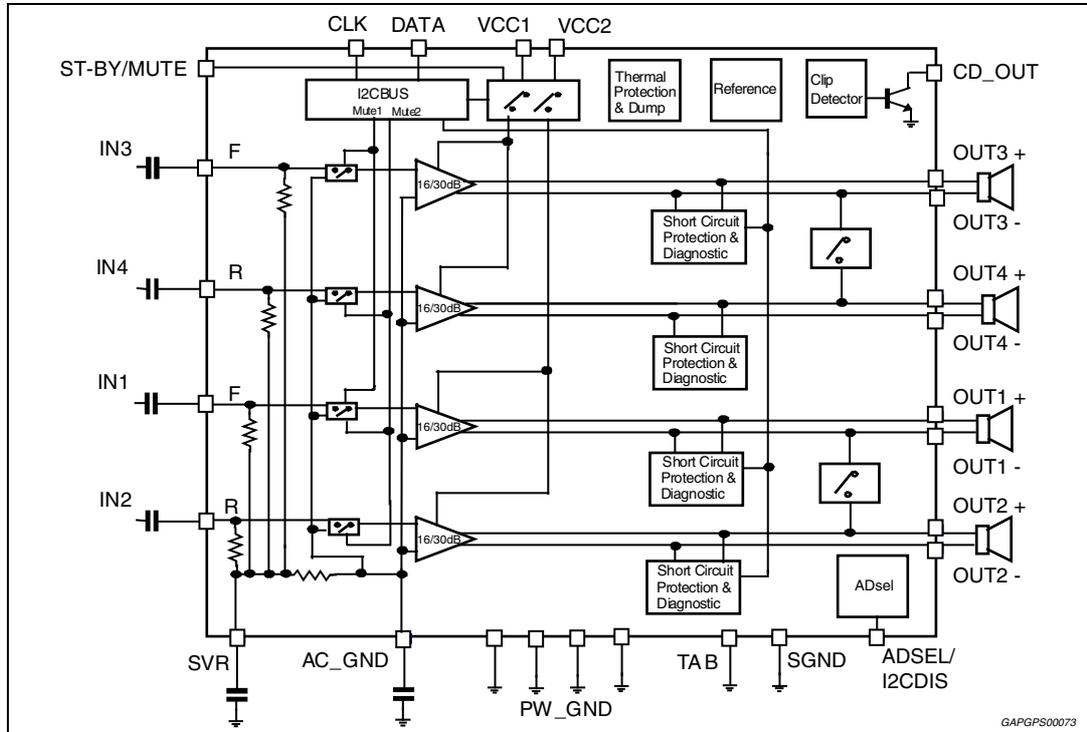
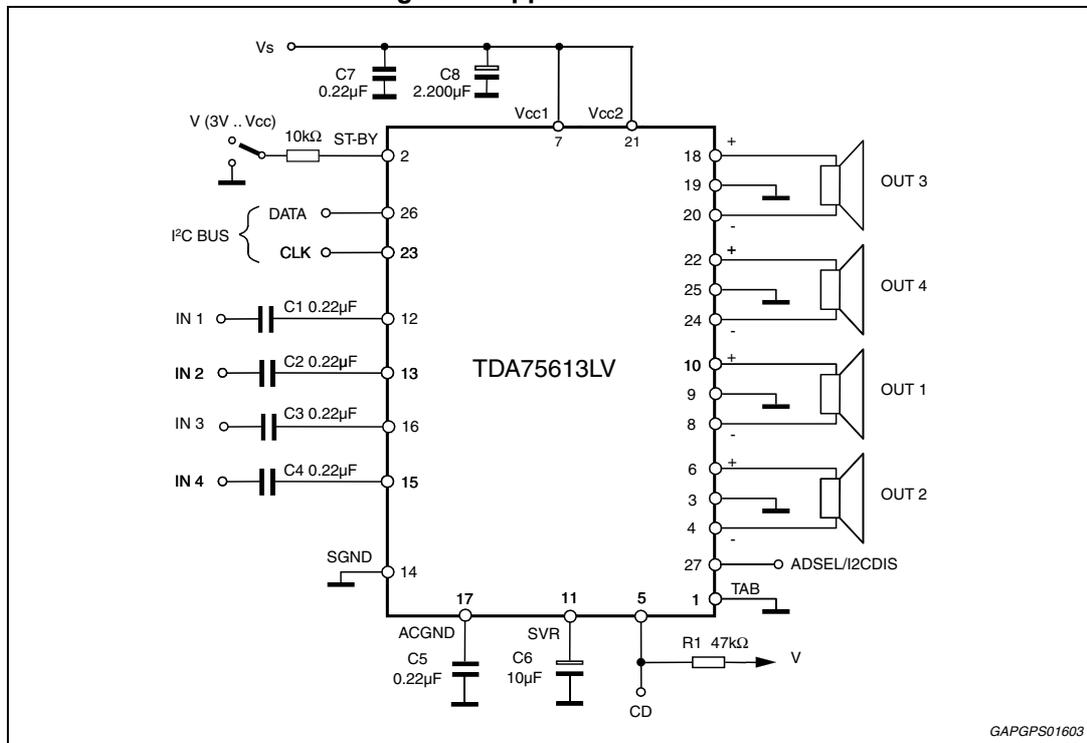


Figure 2. Application circuit



## 2 Pins description

For channel name reference: CH1 = LF, CH2 = LR, CH3 = RF and CH4 = RR.

Figure 3. Pins connection diagram (top of view)

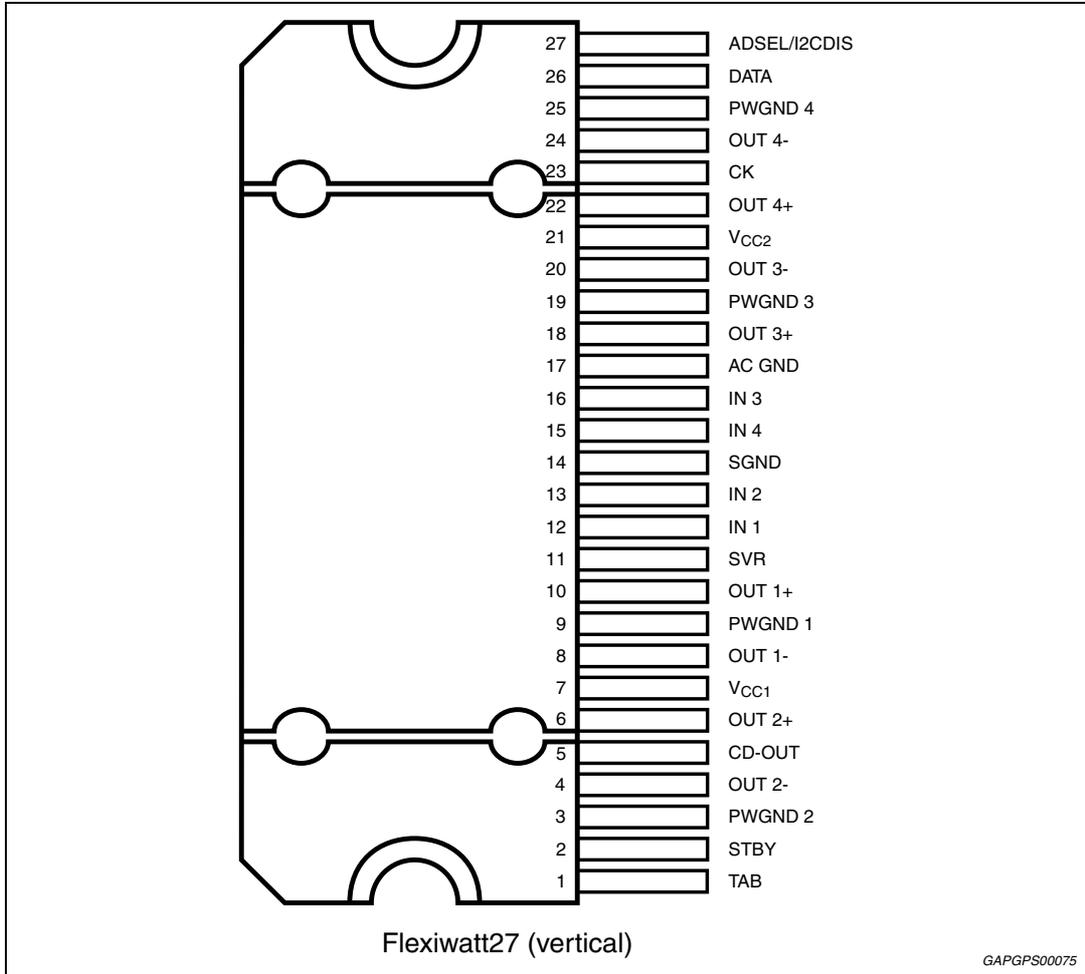


Table 2. Pins list description

Pin #	Pin name	Function
1	TAB	-
2	STBY	Standby pin
3	PWGND2	Channel 2 output power ground
4	OUT2-	Channel 2, - output
5	CD	Clip detector output pin
6	OUT2+	Channel 2, + output
7	VCC1	Supply voltage pin1
8	OUT1-	Channel 1, - output
9	PWGND1	Channel 1 output power ground
10	OUT1+	Channel 1, + output
11	SVR	SVR pin
12	IN1	Input pin, channel 1
13	IN2	Input pin, channel 2
14	SGND	Signal ground pin
15	IN4	Input pin, channel 4
16	IN3	Input pin, channel 3
17	AC GND	AC ground
18	OUT3+	Channel 3, + output
19	PWGND3	Channel 3 output power ground
20	OUT3-	Channel 3, - output
21	VCC2	Supply voltage pin2
22	OUT4+	Channel 4, + output
23	CK	I <sup>2</sup> C bus clock/HE selector
24	OUT4-	Channel 4, - output
25	PWGND4	Channel 4 output power ground
26	DATA	I <sup>2</sup> C bus data pin/gain selector
27	ADSEL/I2CDIS	Address selector pin/ I <sup>2</sup> C bus disable (legacy select)

## 3 Electrical specifications

### 3.1 Absolute maximum ratings

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{op}$	Operating supply voltage <sup>(1)</sup>	18	V
$V_S$	DC supply voltage	28	V
$V_{peak}$	Peak supply voltage (for $t_{max} = 50$ ms)	50	V
GNDmax	Ground pins voltage	-0.3 to 0.3	V
$V_{CK}, V_{DATA}$	CK and DATA pin voltage	-0.3 to 6	V
$V_{cd}$	Clip detector voltage	-0.3 to 5.5	V
$V_{stby}$	STBY pin voltage	-0.3 to $V_{op}$	V
$I_O$	Output peak current (not repetitive $t_{max} = 100$ ms)	8	A
	Output peak current (repetitive $f > 10$ kHz)	6	
$P_{tot}$	Power dissipation $T_{case} = 70^\circ\text{C}$	85	W
$T_{stg}, T_j$	Storage and junction temperature <sup>(2)</sup>	-55 to 150	$^\circ\text{C}$
$T_{amb}$	Operative temperature range	-40 to +105	$^\circ\text{C}$

1. For  $R_L = 2 \Omega$  the output current limit might be reached for  $V_{OP} > 16$  V; thus triggering self-protection.

2. A suitable dissipation system should be used to keep  $T_j$  inside the specified limits.

### 3.2 Thermal data

Table 4. Thermal data

Symbol	Parameter	Value	Unit
$R_{th\ j-case}$	Thermal resistance junction-to-case Max.	1	$^\circ\text{C}/\text{W}$

### 3.3 Electrical characteristics

Refer to the test circuit,  $V_S = 14.4\text{ V}$ ;  $R_L = 4\ \Omega$ ;  $f = 1\text{ kHz}$ ;  $G_V = 30\text{ dB}$ ;  $T_{amb} = 25\text{ }^\circ\text{C}$ ; unless otherwise specified.

**Table 5. Electrical characteristics**

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
<b>General characteristics</b>						
$V_S$	Supply voltage range	$R_L = 4\ \text{ohm}$	6	-	18	V
		$R_L = 2\ \text{ohm}$	6	-	16 <sup>(1)</sup>	
$I_d$	Total quiescent drain current	-	-	165	250	mA
$R_{IN}$	Input impedance	-	45	60	70	k $\Omega$
$V_{AM}$	Min. supply mute threshold	IB1(D7) = 1	7	-	8	V
		IB1(D7) = 0 (default) <sup>(2)</sup>	5	-	6	
$V_{OS}$	Offset voltage	Mute & play	-100	0	100	mV
$V_{dth}$	Dump threshold	-	18.5	19.5	20.5	V
$I_{SB}$	Standby current	$V_{standby} = 0$	-	1	5	$\mu\text{A}$
SVR	Supply voltage rejection	$f = 100\text{ Hz to }10\text{ kHz}$ ; $V_r = 1\text{ Vpk}$ ; $R_g = 600\ \Omega$	55	60	-	dB
$T_{ON}$	Turn on timing (Mute play transition)	D2/D1 (IB1) 0 to 1	-	25	50	ms
$T_{OFF}$	Turn off timing (Play mute transition)	D2/D1 (IB1) 1 to 0	-	25	50	ms
$TH_{WARN1}$	Average junction temperature for TH warning 1	DB1 (D7) = 1	-	160	-	$^\circ\text{C}$
$TH_{WARN2}$	Average junction temperature for TH warning 2	DB4 (D7) = 1	-	145	-	
$TH_{WARN3}$	Average junction temperature for TH warning 3	DB4 (D6) = 1	-	125	-	
<b>Audio performances</b>						
$P_O$	Output power	Max. power <sup>(3)</sup> $V_S = 15.2\text{ V}$ , $R_L = 4\ \Omega$	-	45	-	W
		THD = 10 %, $R_L = 4\ \Omega$	23	25	-	W
		THD = 1 %, $R_L = 4\ \Omega$	-	22	-	W
		$R_L = 2\ \Omega$ ; THD 10 %	-	44	-	W
		$R_L = 2\ \Omega$ ; THD 1 %	-	33	-	W
		$R_L = 2\ \Omega$ ; Max. power <sup>(3)</sup> $V_S = 14.4\text{ V}$	-	64	-	W
		Max power@ $V_S = 6\text{ V}$ , $R_L = 4\ \Omega$	-	5	-	W

Table 5. Electrical characteristics (continued)

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
THD	Total harmonic distortion	$P_O = 1\text{ W to }10\text{ W}$ ; STD mode	-	0.015	0.1	%
		HE MODE; $P_O = 1.5\text{ W}$	-	0.05	0.1	%
		HE MODE; $P_O = 8\text{ W}$	-	0.1	0.5	%
		$P_O = 1\text{-}10\text{ W}$ , $f = 10\text{ kHz}$	-	0.15	0.5	%
		$G_V = 16\text{ dB}$ ; STD Mode $V_O = 0.1\text{ to }5\text{ VRMS}$	-	0.02	0.05	%
$C_T$	Cross talk	$f = 1\text{ kHz to }10\text{ kHz}$ , $R_g = 600\ \Omega$	50	65	-	dB
$G_{V1}$	Voltage gain 1	-	29	30	31	dB
$\Delta G_{V1}$	Voltage gain match 1	-	-1	-	1	dB
$G_{V2}$	Voltage gain 2	-	15	16	17	dB
$\Delta G_{V2}$	Voltage gain match 2	-	-1	-	1	dB
$E_{IN1}$	Output noise voltage 1	$R_g = 600\ \Omega$ 20 Hz to 22 kHz	-	65	80	$\mu\text{V}$
$E_{IN2}$	Output noise voltage 2	$R_g = 600\ \Omega$ ; $G_V = 16\text{ dB}$ 20 Hz to 22 kHz	-	20	30	$\mu\text{V}$
BW	Power bandwidth	-	100	-	-	kHz
CMRR	Input CMRR	$V_{CM} = 1\text{ Vpk-pk}$ ; $R_g = 0\ \Omega$	-	70	-	dB
$\Delta V_{OS}$	During mute ON/OFF output offset voltage	ITU R-ARM weighted (see <a href="#">Figure 18</a> )	-10	-	10	mV
	During standby ON/OFF output offset voltage		-10	-	10	mV
<b>Clip detector</b>						
$CD_{LK}$	Clip det. high leakage current	CD off / $V_{CD} = 6\text{ V}$	-	0	5	$\mu\text{A}$
$CD_{SAT}$	Clip det sat. voltage	CD on; $I_{CD} = 1\text{ mA}$	-	-	300	mV
$CD_{THD}$	Clip det THD level	D0 (IB1) = 1	5	10	15	%
		D0 (IB1) = 0	1	2	3	%
<b>Control pin characteristics</b>						
$V_{SBY}$	Standby/mute pin for standby	-	0	-	1.2	V
$V_{MU}$	Standby/mute pin for mute	-	2.9	-	3.5	V
$V_{OP}$	Standby/mute pin for operating	-	4.5	-	18	V
$I_{MU}$	Standby/mute pin current	$V_{st-by/mute} = 4.5\text{ V}$	-	1	5	$\mu\text{A}$
		$V_{st-by/mute} < 1.2\text{ V}$	-	0	5	$\mu\text{A}$
$A_{SB}$	Standby attenuation	-	90	110	-	dB
$A_M$	Mute attenuation	-	80	100	-	dB

**Table 5. Electrical characteristics (continued)**

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
<b>Turn on diagnostics 1 (Power amplifier mode)</b>						
Pgnd	Short to GND det. (below this limit, the Output is considered in short circuit to GND)	Power amplifier in standby	-	-	1.2	V
Pvs	Short to Vs det. (above this limit, the output is considered in short circuit to Vs)		Vs -1.2	-	-	V
Pnop	Normal operation thresholds. (Within these limits, the output is considered without faults).		1.8	-	Vs -1.8	V
Lsc	Shorted load det.		-	-	0.5	Ω
Lop	Open load det.		85	-	-	Ω
Lnop	Normal load det.		1.5	-	45	Ω
<b>Turn on diagnostics 2 (Line driver mode)</b>						
Pgnd	Short to GND det. (below this limit, the output is considered in short circuit to GND)	Power amplifier in standby	-	-	1.2	V
Pvs	Short to Vs det. (above this limit, the output is considered in short circuit to Vs)	-	Vs -1.2	-	-	V
Pnop	Normal operation thresholds. (Within these limits, the output is considered without faults).	-	1.8	-	Vs -1.8	V
Lsc	Shorted load det.	-	-	-	1.5	Ω
Lop	Open load det.	-	330	-	-	Ω
Lnop	Normal load det.	-	7	-	180	Ω
<b>Permanent diagnostics 2 (Power amplifier mode or line driver mode)</b>						
Pgnd	Short to GND det. (below this limit, the Output is considered in short circuit to GND)	Power amplifier in mute or play, one or more short circuits protection activated	-	-	1.2	V
Pvs	Short to Vs det. (above this limit, the output is considered in short circuit to Vs)		Vs -1.2	-	-	V
Pnop	Normal operation thresholds. (Within these limits, the output is considered without faults).		1.8	-	Vs -1.8	V
L <sub>SC</sub>	Shorted load det.	Power amplifier mode	-	-	0.5	Ω
		Line driver mode	-	-	1.5	Ω
V <sub>O</sub>	Offset detection	Power amplifier in play, AC input signals = 0	±1.5	±2	±2.5	V

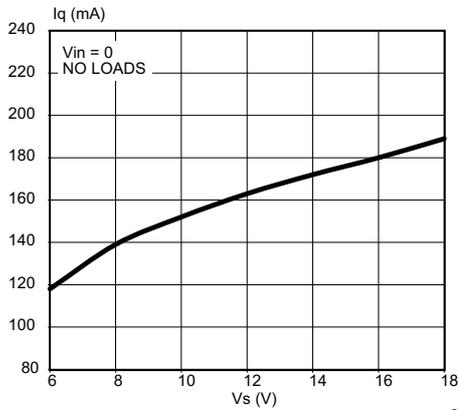
Table 5. Electrical characteristics (continued)

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
$I_{NLH}$	Normal load current detection	$V_O < (V_S - 5)\mu\text{k}$ , IB2 (D7) = 0	500	-	-	mA
$I_{OLH}$	Open load current detection		-	-	250	mA
$I_{NLL}$	Normal load current detection	$V_O < (V_S - 5)\mu\text{k}$ , IB2 (D7) = 1	250	-	-	mA
$I_{OLL}$	Open load current detection		-	-	125	mA
<b>I<sup>2</sup>C bus interface</b>						
$S_{CL}$	Clock frequency	-	-	-	400	kHz
$V_{IL}$	Input low voltage	-	-	-	1.5	V
$V_{IH}$	Input high voltage	-	2.3	-	-	V

1. When  $V_S > 16$  V the output current limit is reached (triggering embedded internal protections).
2. In legacy mode only low threshold option is available.
3. Saturated square wave output.

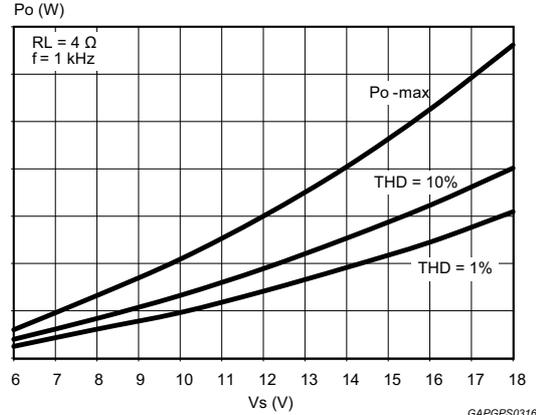
### 3.4 Electrical characteristic curves

Figure 4. Quiescent current vs. supply voltage



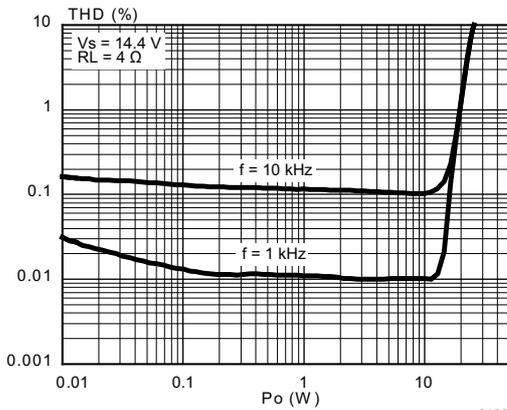
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Figure 5. Output power vs. supply voltage (4 Ω)



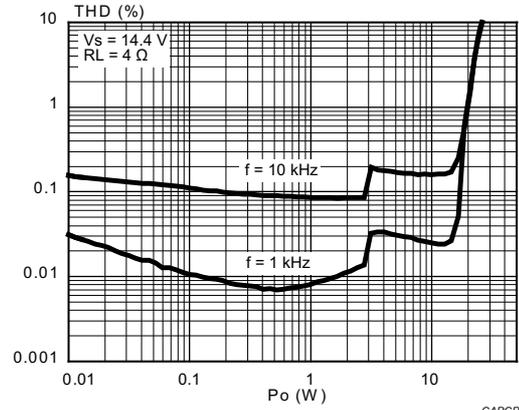
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Figure 6. Distortion vs. output power (4 Ω, STD)



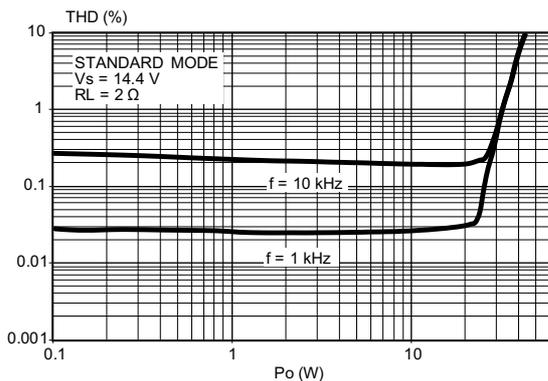
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Figure 7. Distortion vs. output power (4 Ω, HI-EFF)



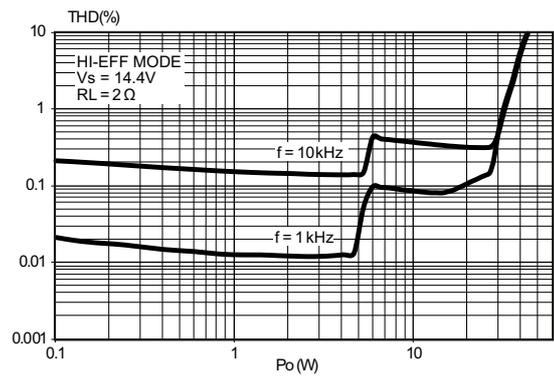
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Figure 8. Distortion vs. output power (2 Ω, STD)



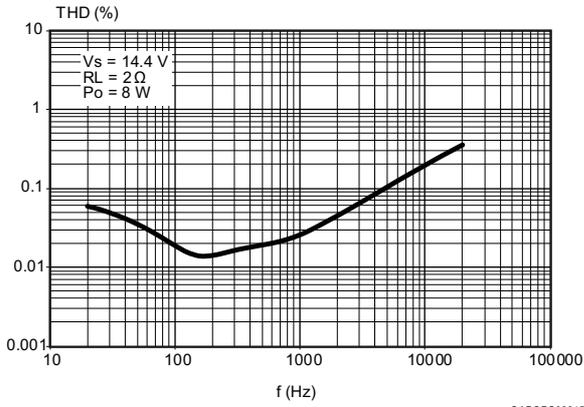
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Figure 9. Distortion vs. output power (2 Ω, HI-EFF)

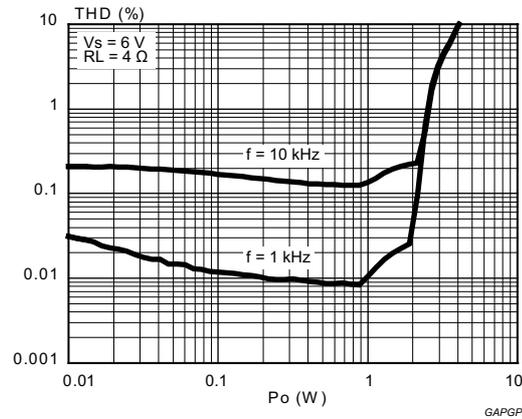


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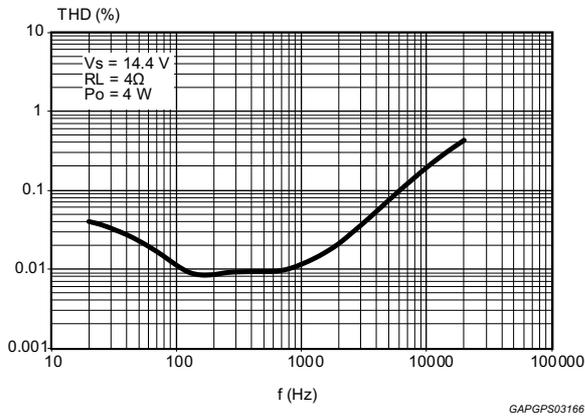
**Figure 10. Distortion vs. frequency (2 Ω, 8W,STD)**



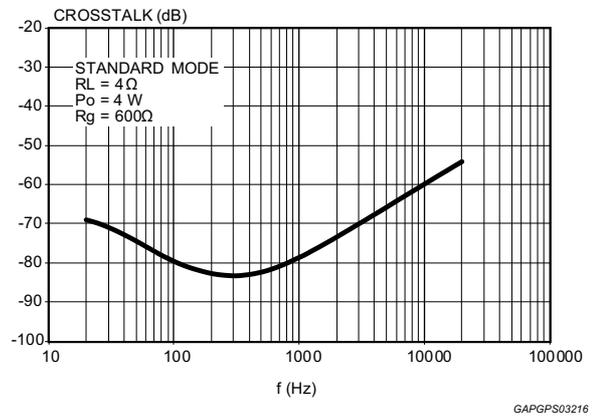
**Figure 11. Distortion vs. output power  $V_s = 6\text{ V}$  (4 Ω, STD)**



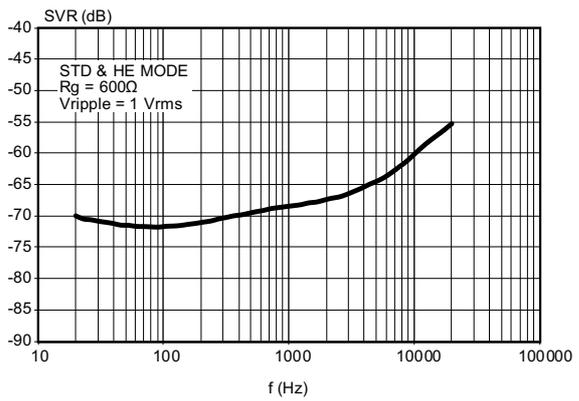
**Figure 12. Distortion vs. frequency (4 Ω, 4W, STD)**



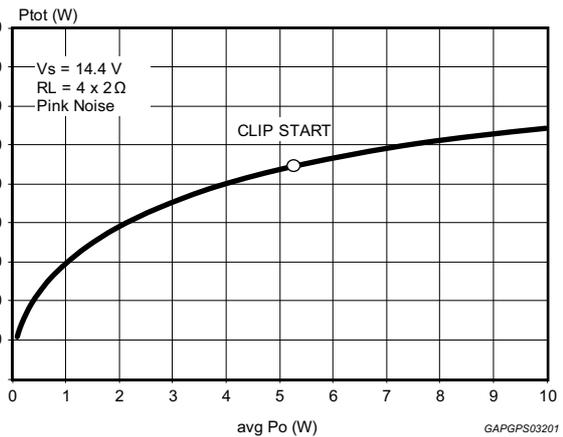
**Figure 13. Crosstalk vs. frequency**



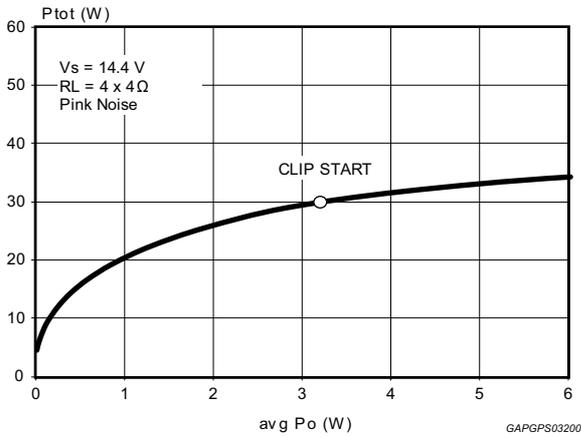
**Figure 14. Supply voltage rejection vs. frequency**



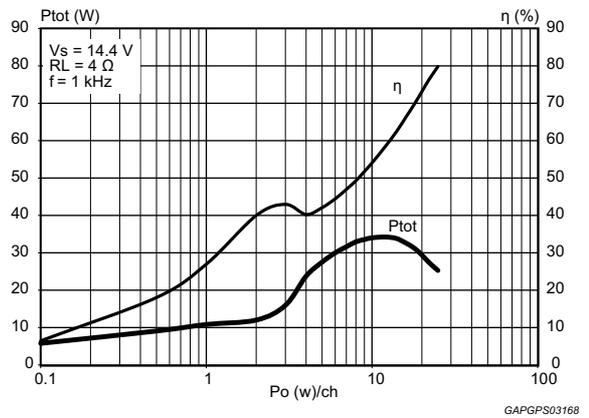
**Figure 15. Power dissipation vs. average  $P_o$  (audio program simulation, 2 Ω)**



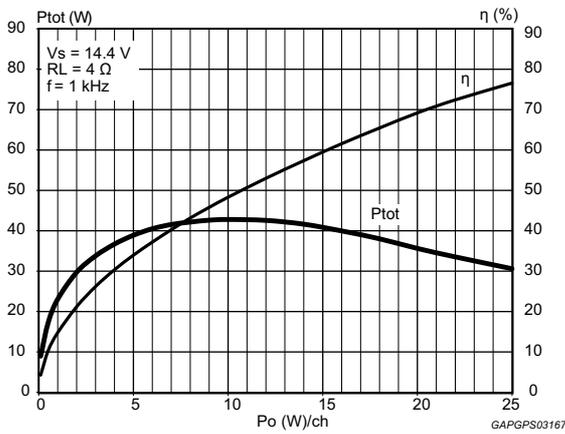
**Figure 16. Power dissipation vs. average Po (audio program simulation, 4 Ω)**



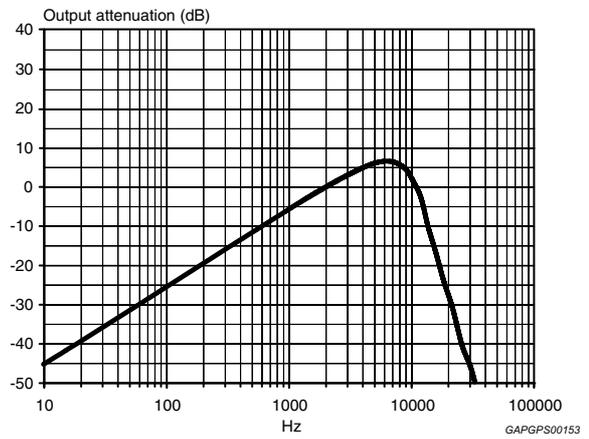
**Figure 17. Total power dissipation & efficiency vs. output power (4 Ω, HI-EFF, Sine)**



**Figure 18. Total power dissipation & efficiency vs. output power (4 Ω, STD, Sine)**



**Figure 19. ITU R-ARM frequency response, weighting filter for transient pop**



## 4 Diagnostics functional description

### 4.1 Turn-on diagnostic

It is recommended to activate this function at the turn-on (standby out) through an I<sup>2</sup>C bus request. Detectable output faults are:

- Short to GND
- Short to V<sub>s</sub>
- Short across the speaker
- Open speaker

To verify if any of the above misconnections are in place, a subsonic (inaudible) current pulse (Figure 20) is internally generated, sent through the speaker(s) and sunk back. The Turn On diagnostic status is internally stored until a successive diagnostic pulse is requested (after a I<sup>2</sup>C reading).

If the "standby out" and "diag. enable" commands are both given through a single programming step, the pulse takes place first (during the pulse the power stage stays 'off', showing high impedance at the outputs).

Afterwards, when the Amplifier is biased, the PERMANENT diagnostic takes place. The previous turn-on state is kept until a short appears at the outputs.

Figure 20. Turn-on diagnostic: working principle

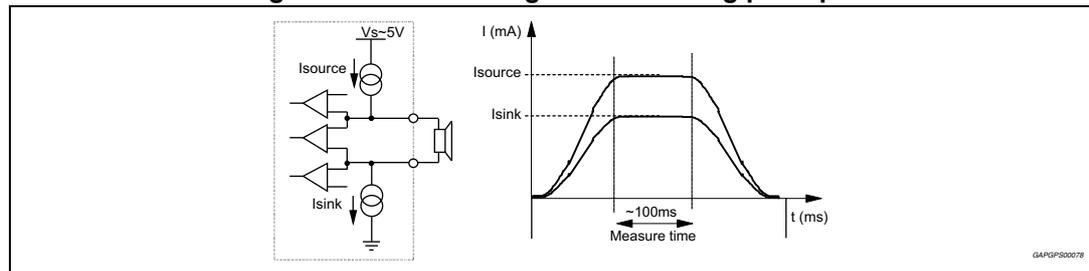


Figure 21 and 22 show SVR and OUTPUT waveforms at the turn-on (standby out) with and without turn-on diagnostic.

Figure 21. SVR and output behavior (Case 1: without turn-on diagnostic)

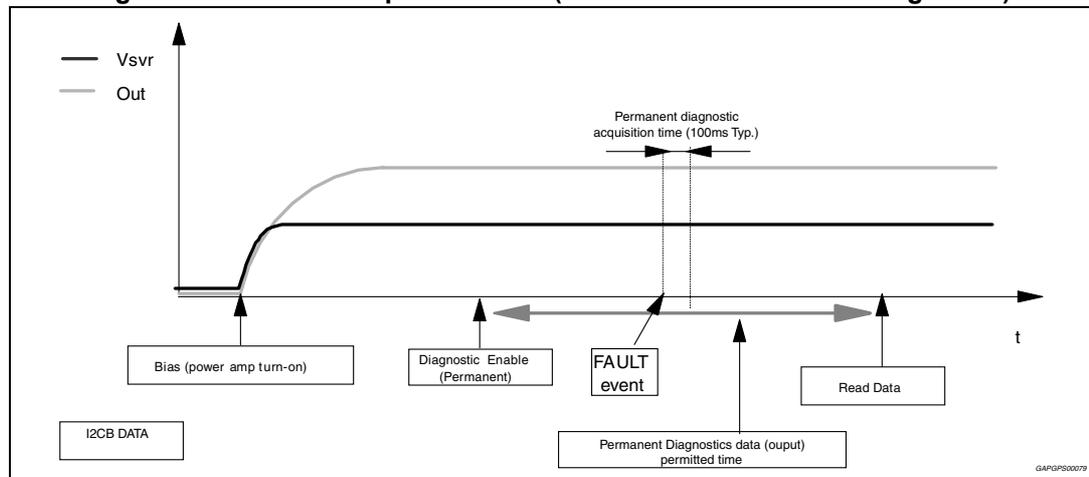
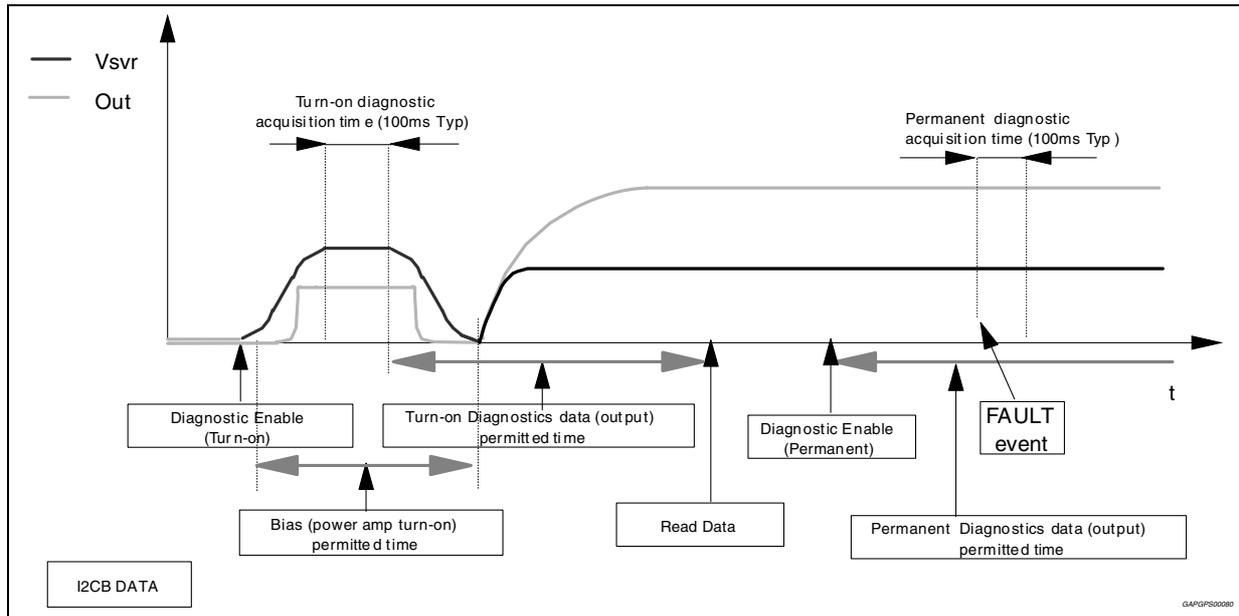
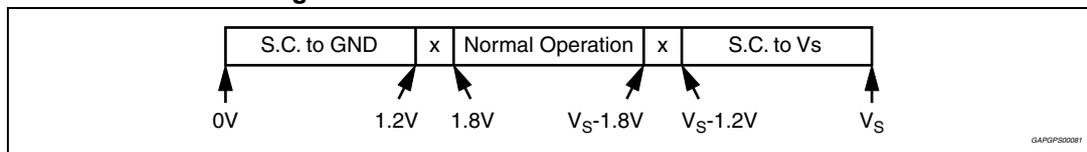


Figure 22. SVR and output pin behavior (Case 2: with turn-on diagnostic)



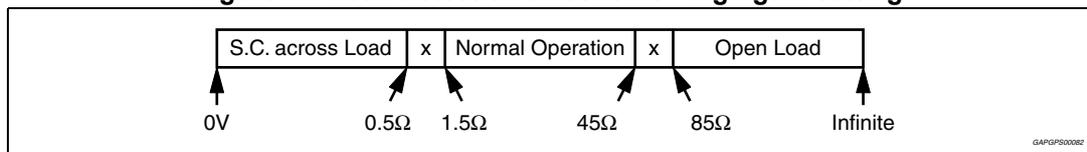
The information related to the outputs status is read and memorized at the end of the current pulse plateau. The acquisition time is 100 ms (typ.). No audible noise is generated in the process. As for SHORT TO GND / Vs the fault-detection thresholds remain unchanged from 30 dB to 16 dB gain setting. They are as follows:

Figure 23. Short circuit detection thresholds



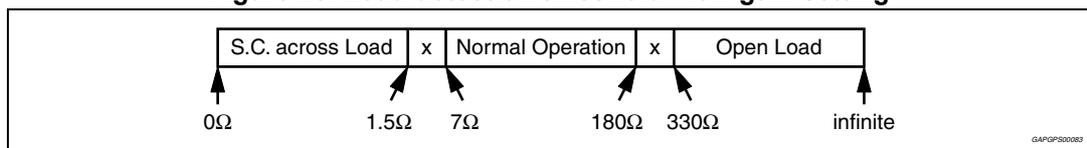
Concerning SHORT ACROSS THE SPEAKER / OPEN SPEAKER, the threshold varies from 30 dB to 16 dB gain setting, since different loads are expected (either normal speaker's impedance or high impedance). The values in case of 30 dB gain are as follows:

Figure 24. Load detection thresholds - high gain setting



If the Line-Driver mode ( $G_v = 16$  dB and Line Driver Mode diagnostic = 1) is selected, the same thresholds will change as follows:

Figure 25. Load detection threshold - low gain setting



## 4.2 Permanent diagnostics

Detectable conventional faults are:

- Short to GND
- Short to Vs
- Short across the speaker

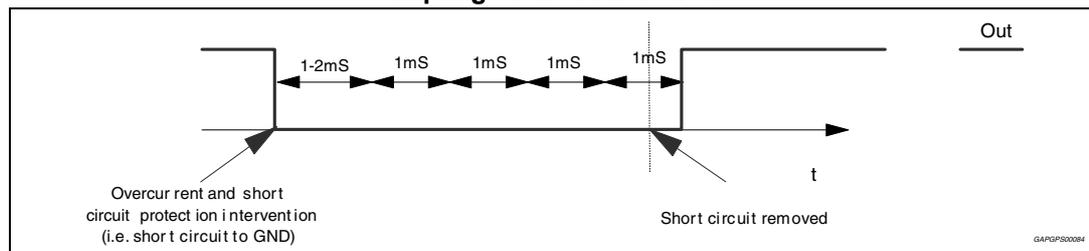
The following additional feature is provided:

- Output offset detection (see [Section 5](#))

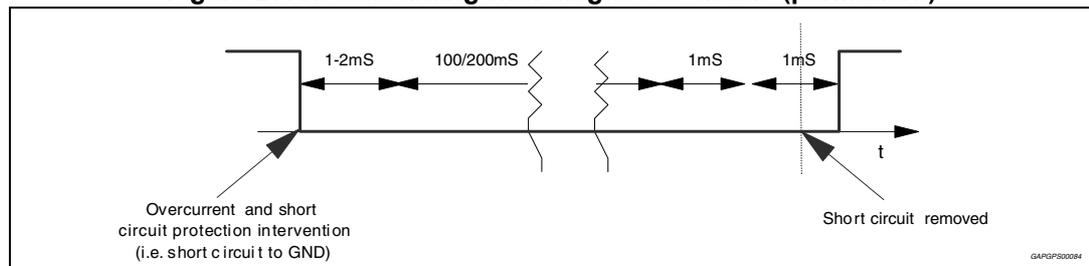
The TDA75613LV has 2 operating status:

1. **RESTART mode.** The diagnostic is not enabled. Each audio channel operates independently of each other. If any of the a.m. faults occurs, only the channel(s) interested is shut down. A check of the output status is made every 1 ms ([Figure 26](#)). Restart takes place when the overload is removed.
2. **DIAGNOSTIC mode.** It is enabled via I<sup>2</sup>C bus and it self activates if an output overload (such as to cause the intervention of the short-circuit protection) occurs to the speakers outputs. Once activated, the diagnostics procedure develops as follows ([Figure 27](#)):
  - To avoid momentary re-circulation spikes from giving erroneous diagnostics, a check of the output status is made after 1ms: if normal situation (no overloads) is detected, the diagnostic is not performed and the channel returns active.
  - Instead, if an overload is detected during the check after 1 ms, then a diagnostic cycle having a duration of about 100 ms is started.
  - After a diagnostic cycle, the audio channel interested by the fault is switched to RESTART mode. The relevant data are stored inside the device and can be read by the microprocessor. When one cycle has terminated, the next one is activated by an I<sup>2</sup>C reading. This is to ensure continuous diagnostics throughout the car-radio operating time.
  - To check the status of the device a sampling system is needed. The timing is chosen at microprocessor level (over half a second is recommended).

**Figure 26. Restart timing without diagnostic enable (permanent) - Each 1 mS time, a sampling of the fault is done**



**Figure 27. Restart timing with diagnostic enable (permanent)**



### 4.3 AC diagnostic

It is targeted at detecting accidental disconnection of tweeters in 2-way speaker and, more in general, presence of capacitive (AC) coupled loads.

This diagnostic is based on the notion that the overall speaker's impedance (woofer + parallel tweeter) will tend to increase towards high frequencies if the tweeter gets disconnected, because the remaining speaker (woofer) would be out of its operating range (high impedance). The diagnostic decision is made according to peak output current thresholds, and it is enabled by setting  $IB2-D2 = 1$ . Two different detection levels are available:

- High current threshold  $IB2(D7) = 0$   
lout > 500 mA<sub>pk</sub> = normal status  
lout < 250 mA<sub>pk</sub> = open tweeter
- Low current threshold  $IB2(D7) = 1$   
lout > 250 mA<sub>pk</sub> = normal status  
lout < 125 mA<sub>pk</sub> = open tweeter

To correctly implement this feature, it is necessary to briefly provide a signal tone (with the amplifier in "play") whose frequency and magnitude are such to determine an output current higher than 500 mA<sub>pk</sub> with  $IB2(D7) = 0$  (higher than 250 mA<sub>pk</sub> with  $IB2(D7) = 1$ ) in normal conditions and lower than 250 mA<sub>pk</sub> with  $IB2(D7) = 0$  (lower than 125 mA<sub>pk</sub> with  $IB2(D7)=1$ ) should the parallel tweeter be missing.

The test has to last for a minimum number of 3 sine cycles starting from the activation of the AC diagnostic function  $IB2-D2$  up to the I<sup>2</sup>C reading of the results (measuring period). To confirm presence of tweeter, it is necessary to find at least 3 current pulses over the above threshold over all the measuring period, else an "open tweeter" message will be issued.

The frequency / magnitude setting of the test tone depends on the impedance characteristics of each specific speaker being used, with or without the tweeter connected (to be calculated case by case). High-frequency tones (> 10 kHz) or even ultrasonic signals are recommended for their negligible acoustic impact and also to maximize the impedance module's ratio between with tweeter-on and tweeter-off.

*Figure 28* and *29* shows the load impedance as a function of the peak output voltage and the relevant diagnostic fields.

It is recommended to keep output voltage always below 8 V (high threshold case) or 4 V (low threshold case) to avoid the circuit to saturate (causing wrong detection cases).

This feature is disabled if any overload leading to activation of the short-circuit protection occurs in the process.

Figure 28. Current detection high: load impedance |Z| vs. output peak voltage

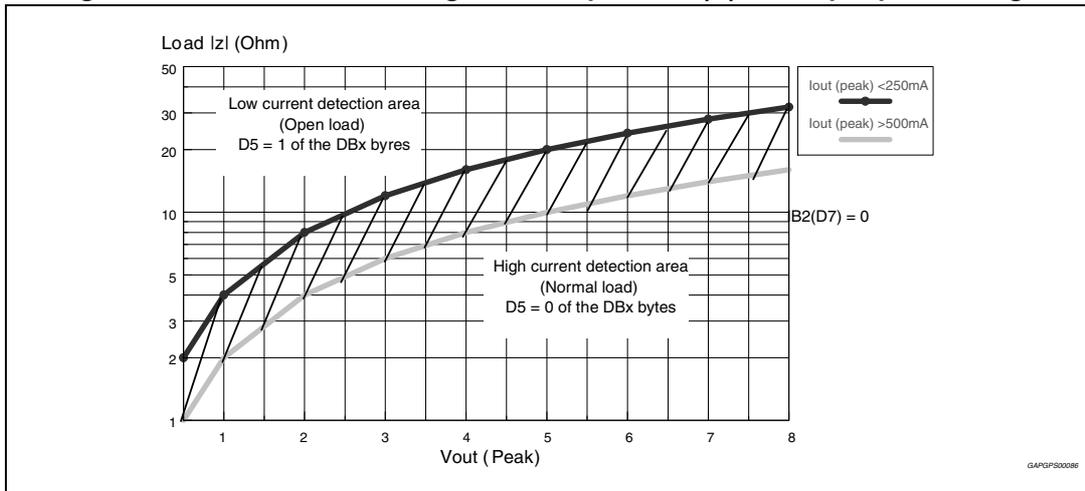
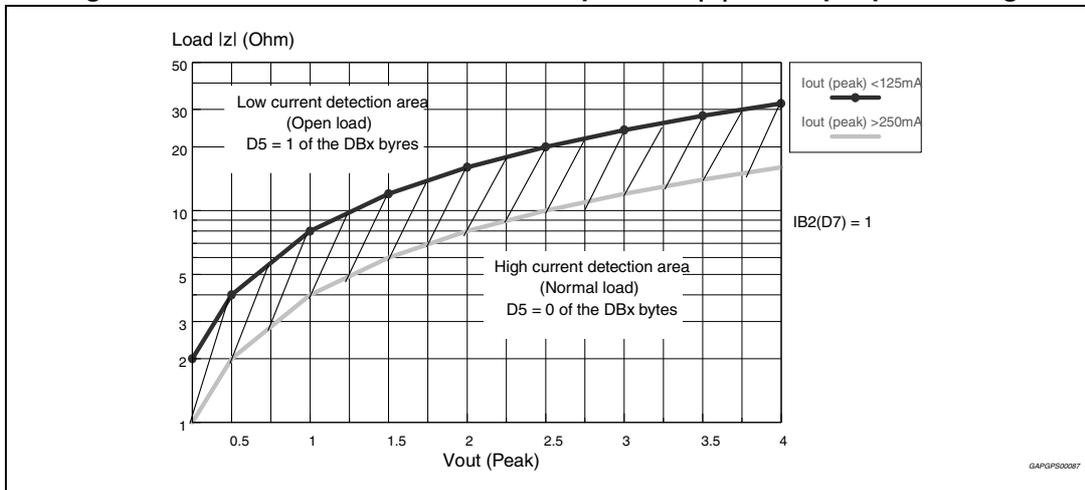


Figure 29. Current detection low: load impedance |Z| vs. output peak voltage



## 5 Output DC offset detection

The TDA75613LV can detect any DC output offset exceeding  $\pm 2$  V. This inconvenient might occur as a consequence of initially defective or aged and worn-out input capacitors feeding a DC component to the inputs, so putting the speakers at risk of overheating. Every time the power amplifier switches on, the SSR automatically mutes the device in case of offset. In play mode, the offset is signalled out on I<sup>2</sup>C bus.

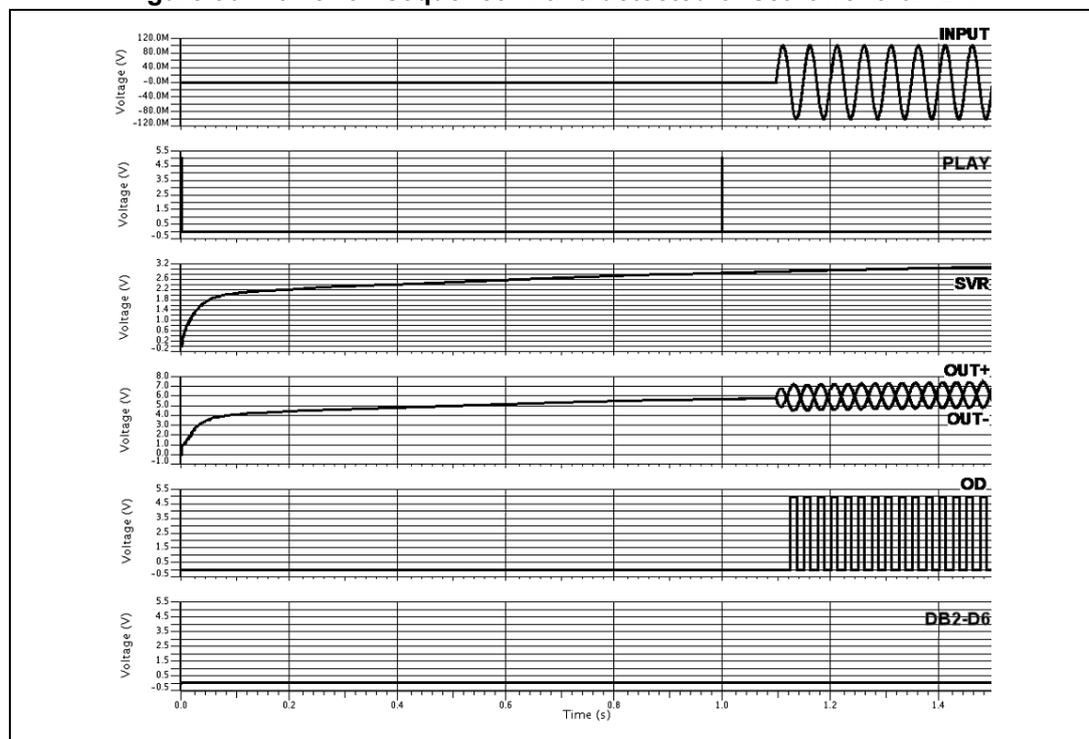
### 5.1 Offset detection and mute at start-up, SSR (Speaker Safety Routine)

TDA75613LV embeds a speaker safety routine in order to protect the speakers in case of big output offset. This protection mechanism can automatically mute the device within 40 ms when it detects an offset bigger than 2 V at the output. No external circuit is required for this feature.

The SSR requires the MCU to turn on the audio power amplifier in a proper sequence. The MCU should at first turn on the device in MUTE condition and, after a suitable time to completely power on the device, which is about 1s, send a PLAY command to it and make sure there is no input signal applied to any of the inputs for at least 100 ms.

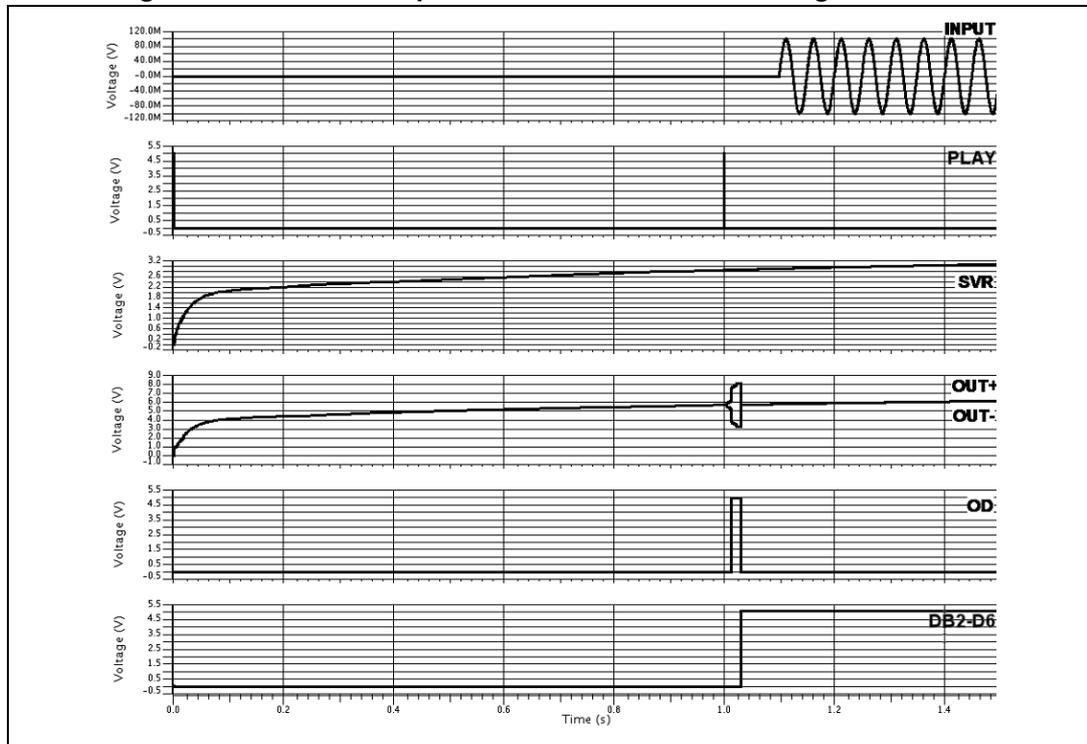
See [Figure 30](#). The power amplifier switches on and no input signal is applied. After 1 s the SVR is fully charged and the output dc voltage is set. The MCU sends the PLAY command and the offset, on all the channels, is checked. In case the detected offset is null or, anyhow, lower than 2 V, the power amplifier is kept alive and the audio signal can be applied after 100 ms.

**Figure 30. Power on sequence with a detected offset lower than 2 V**



Look at the [Figure 31](#). The power amplifier switches on and no input signal is applied. After 1 s the SVR is fully charged and the output dc voltage is set. The MCU sends the PLAY command and the offset, on all the channels, is checked. If an offset bigger than 2 V is detected, the power amplifier is switched off within 40 ms.

**Figure 31. Power on sequence with a detected offset higher than 2 V**



This action is pointed out on the I<sup>2</sup>C bus, bit DB2-D6. This flag is seen by the microcontroller which can take necessary actions.

A standby command (hardware or by I<sup>2</sup>C) can reset the power amplifier

## 5.2 Offset detection in normal operation

It is a diagnostics function which has to be performed with low-level output AC signal (or  $V_{in} = 0$ ).

The test is run with selectable time duration by microprocessor (from a "start" to a "stop" command):

- START = Last reading operation or setting IB1 - D5 - (OFFSET enable) to 1
- STOP = Actual reading operation

Excess offset is signalled out if it is persistent for all the assigned testing time. This feature is disabled if any overloads leading to activation of the short-circuit protection occurs in the process.

## 6 Multiple faults

When more misconnections are simultaneously in place at the audio outputs, it is guaranteed that at least one of them is initially read out. The others are notified after successive cycles of I<sup>2</sup>C reading and faults removal, provided that the diagnostic is enabled. This is true for both kinds of diagnostic (Turn-On and Permanent).

The table below shows all the couples of double-fault possible. It should be taken into account that a short circuit with the 4 ohm speaker unconnected is considered as double fault.

**Table 6. Double fault table for turn on diagnostic**

	S. GND	S. Vs	S. Across L.	Open L.
S. GND	S. GND	S. Vs + S. GND	S. GND	S. GND
S. Vs	/	S. Vs	S. Vs	S. Vs
S. Across L.	/	/	S. Across L.	N.A.
Open L.	/	/	/	Open L. (*)

In Permanent Diagnostic the table is the same, with only a difference concerning Open Load (\*), which is not among the recognizable faults. Should an Open Load be present during the device's normal working, it would be detected at a subsequent Turn-On Diagnostic cycle (i.e. at the successive Car Radio Turn-On).

### 6.1 Faults availability

All the results coming from I<sup>2</sup>C bus, by read operations, are the consequence of measurements inside a defined period of time. If the fault is stable throughout the whole period, it will be sent out.

To guarantee always resident functions, every kind of diagnostic cycle (Turn-On, Permanent, Offset) is activated again after any I<sup>2</sup>C reading operation. So, when the micro reads the I<sup>2</sup>C, a new cycle will be able to start, but the read data will come from the previous diag. cycle (i.e. The device is in Turn-On state, with a short to GND, then the short is removed and micro reads I<sup>2</sup>C. The short to GND is still present in bytes, because it is the result of the previous cycle. If another I<sup>2</sup>C reading operation occurs, the bytes do not show the short). In general to observe a change in Diagnostic bytes, two I<sup>2</sup>C reading operations are necessary.

## 7 Thermal protection

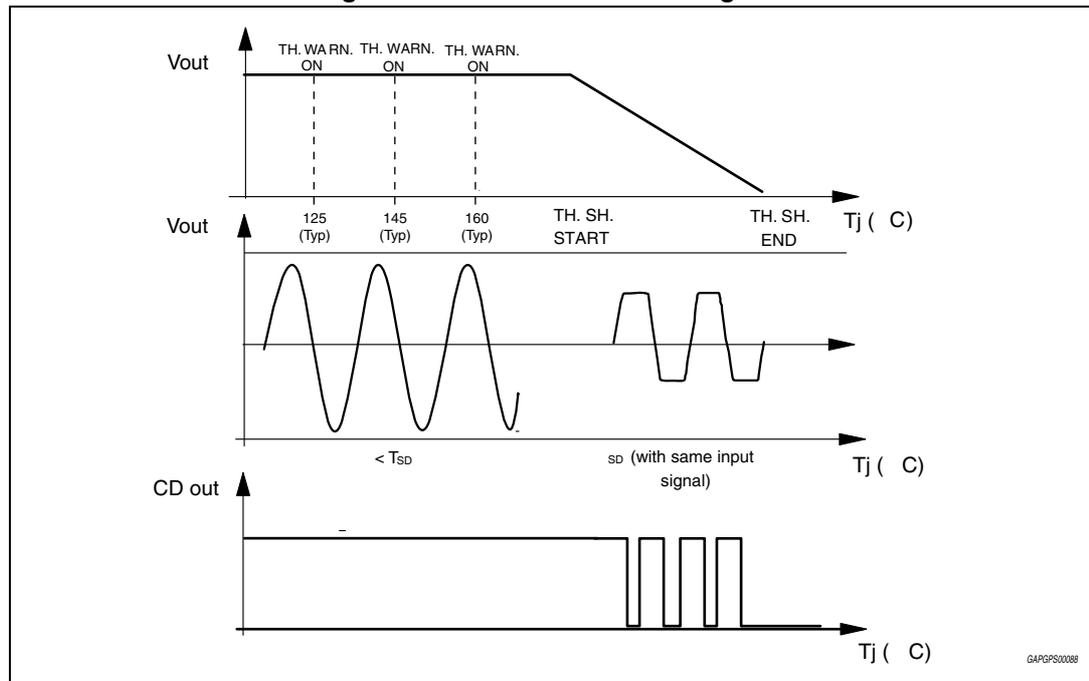
Thermal protection is implemented through thermal foldback (*Figure 32*).

Thermal foldback begins limiting the audio input to the amplifier stage as the junction temperatures rise above the normal operating range. This effectively limits the output power capability of the device thus reducing the temperature to acceptable levels without totally interrupting the operation of the device.

The output power will decrease to the point at which thermal equilibrium is reached. Thermal equilibrium will be reached when the reduction in output power reduces the dissipated power such that the die temperature falls below the thermal foldback threshold. Should the device cool, the audio level will increase until a new thermal equilibrium is reached or the amplifier reaches full power. Thermal foldback will reduce the audio output level in a linear manner.

Three thermal warnings are available through the I<sup>2</sup>C bus data. After thermal shut down threshold is reached, the CD could toggle (as shown in *Figure 32*) or stay low, depending on signal level.

**Figure 32. Thermal foldback diagram**



### 7.1 Fast muting

The muting time can be shortened to less than 1.5ms by setting (IB2) D5 = 1. This option can be useful in transient battery situations (i.e. during car engine cranking) to quickly turnoff the amplifier to avoid any audible effects caused by noise/transients being injected by preamp stages. The bit must be set back to “0” shortly after the mute transition.